FCPA DX µJewel Series

Product Features

- Custom-fit pulse energy and average powers
- Burst Mode capable
- Pulse Select: Allows users to select up to 15 pre-set repetition rate values; typical rates range from 100 kHz to 5 MHz
- Pulse On-Demand: single pulse to standard pulse repetition rate
- Optional SHG module
- Remote diagnostic testing and in-field configuration
- Mechanical reliability complies with relevant MIL-STD-810F and IEC 60601-1 requirements

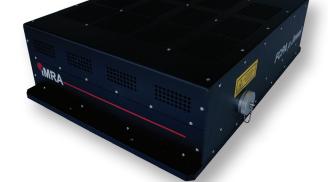
Typical Configurations*

	DX0210	DX0320	DX0540
Wavelength	1045 nm		
Average Power (max)	≥ 2 W	≥ 3 W	≥ 5 W
Pulse Energy (max)	≥ 10 µJ	≥ 20 µJ	≥ 40 µJ
Standard Repetition Rate	100 kHz	100 kHz	100 kHz
Pulse Duration		≤ 450 fs	

^{*}Other configurations available for specialized and OEM applications, e.g. higher average power, higher pulse energy, other repetition rate

Applications

- Glass Welding
- Wafer Processing
- Thin Film Ablation
- Marking
- Microprocessing
- Ceramic Processing





DX Specifications		
Beam Quality	$M^2 \le 1.3$	
Polarization	Horizontal with respect to baseplate	
Power Stability	≤ 1% RMS after stabilization over ± 1 °C	
Output Aperture Height	55.4 mm	
Laser Head Dimensions	550 x 400 x 149 mm ³	
Laser Head Weight	≤ 25 kg	
Head Heat Dissipation	Max. 80 W	
Controller Dimensions	433 x 483 x 222 mm ³	
Controller Weight	≤ 30 kg	
Power Consumption	≤ 600 W	
Operating Voltage	100-120/200-240 VAC	
Output Trigger	+3V, 100 ns wide, 150 ns before optical pulse	
Operating Temperature	20 - 30 ℃	
Storage Temperature	0 - 50 °C	
Warm-up Time	≤ 60 minutes	
Cable Length	3 m	



DX-Series Warning Label



NOTE: Specifications and features may change without notice